





Transmittal of Patent Application - Rule 1.53(b)

Box: Patent Application Commissioner for Patents Washington, DC 20231

Inventor(s): Kurt C. Melancon, Anthony M. Kremer, Audrey A. Sherman, Zhiming Zhou, Michael L. Tumey, Duane A. Lunsford

Title: SILICONE PRESSURE SENSITIVE ADHESIVES, ARTICLES, AND METHODS

- 1.

 Enclosed is the above-mentioned new patent application. It includes _____ sheet(s) of drawings.
- Enclosed is an executed declaration or oath.
- 3. Vox Enclosed are an application assignment to 3M Innovative Properties Company and a completed Assignment Recordation Cover Sheet.
- Enclosed is a Certified Copy of Priority Document(s) _______ (if foreign priority is claimed).
- Enclosed is

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The fee for filing the application is computed as follows:

			Claims A	s Filed		
(1) For	(2) Number Filed		(3) Number Extra	(4) Rate		(5) Basic Fee \$740
Total Claims	63	-20 =	43	x S	18	\$774
Independent Claims	6	-3 =	3	x S	84	\$252
Additional fee for filing one or more multiple dependent claims				\$2	80	\$-0-
				Total amount	due →	\$1766

- 7. Image: Please charge to Deposit Account 13-3723 any fees under 37 CFR 1.16 and 1.17 which may be required to file and during the entire pendency of this application. This authorization includes the fee for any extension of time under 37 CFR 1.13(a) that may be necessary. To the extent any such extension should become necessary it is hereby requested. A copy of this transmittal letter for fee processing is enclosed.
- 8. Enclosed is a return receipt postcard

Registration Number	Telephone Number			
33,025	(651) 737-2685			
12/18/01				

Respectfully submitted

Daniel R	Postil
Printed Name	
Daniel R. Pastirik	

Pursuant to 37 CFR 1.10 I certify that this application is being deposited on the date indicated below with the United States Postal Service "Express Mail Post Office to Addressee" service addressed to: Commissioner for Patents, Washington, DC 20231.

Express Mail Manuel place I No.

ELS97086650US

Date of Posposit

All Royal DO 1 R 2001

Beth M. Lindblom

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